



SPACE TRIPS SUMMER SCHOOL



Theme 9: SPACE

Riga **Latvia**

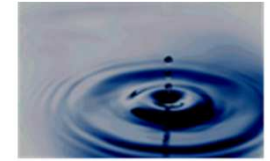
June 17-20 , 2 0 1 4

COLD SOURCE IN SPACE

Enrico SACCHI

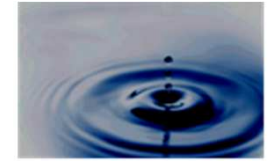
THALES ALENIA SPACE





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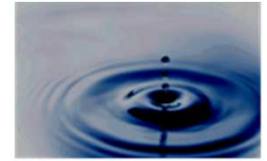
1. Introduction
2. Space Thermal Environment and Heat Transfer
3. Thermal Architecture (Heat Transfer to a S/C Cold Sink)
 - Passive (heat pipes, LHP)
 - Active (ATCS)
4. Cold Sink (Radiator)
5. Future development (High Temperature Heat Pipes, LHP, lightweight radiators, droplet)
6. Conclusions



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1. INTRODUCTION

- Basic thermal concepts in Space: what is the meaning of
 - *Thermal Environment*
 - *Energy Balance*
 - *Heat Collection, Transfer and Rejection*
 - *Heat Sink*
- Thermal design solutions and performance



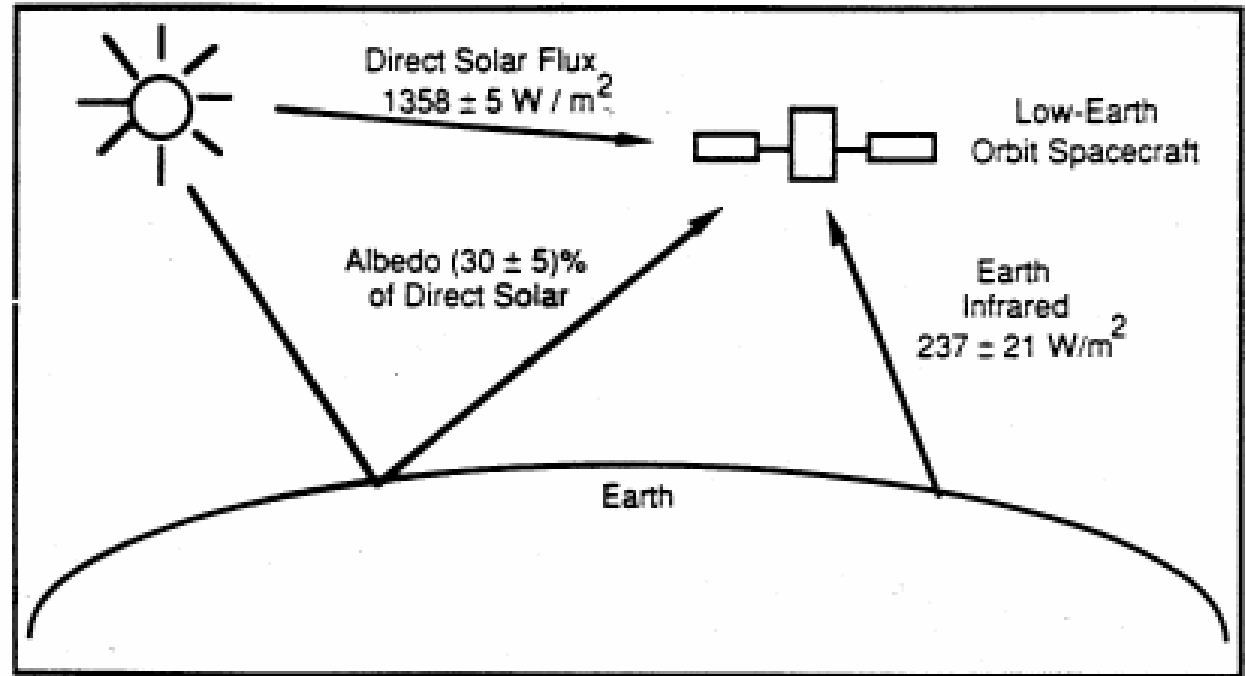
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2. SPACE THERMAL ENVIRONMENT AND HEAT TRANSFER

Energy sources:

the Sun

- diameter 1.39 Mkm
- mass $1.99 \cdot 10^{30}$ kg
- Surface T 5780 K
- radiation arriving from the Sun not constant. (average value of $\sim 1358 \text{ W/m}^2$)



the Albedo (solar): fraction of the incident solar energy reflected by the planet surface back to space

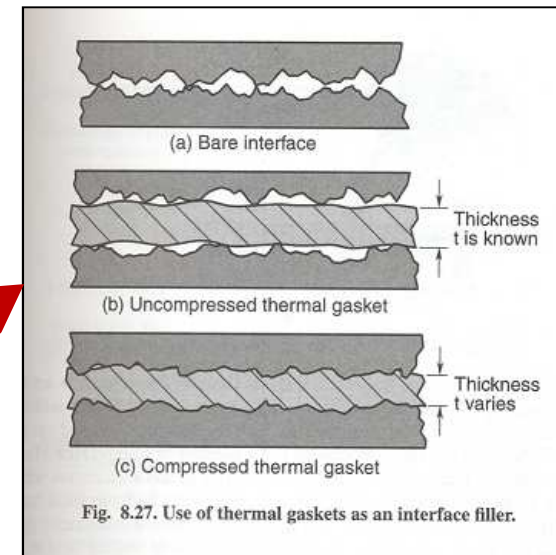
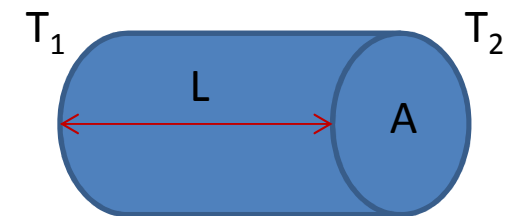
the Planet Emitted Radiation: Infrared Energy re-emitted by a planet mainly in the wavelength field $\lambda > 0.8$ micron

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2. SPACE THERMAL ENVIRONMENT AND HEAT TRANSFER

➤ Heat Transfer by **Conduction** (materials): $Q = (KA/L) (T_1 - T_2) \rightarrow \text{LINEAR}$

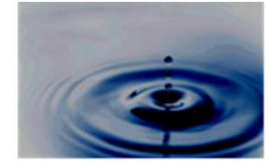
- **A** = area [m^2], **L**=length [m]
- **K**= material Thermal Conductivity [W/m C],
- High Thermal conductivity materials:
 - Diamond $k=1000$ [W/m C]
 - CFRP (hi K) $k= \text{up to } 400$ [W/m C]
 - Copper $k= \text{up to } 380$ [W/m C]
 - Aluminum $k= 150/200$ [W/m C]
- Low Thermal conductivity materials:
 - Ti alloy /Stainless steel $k= 7 \text{ to } 16,3$ [W/m C]
 - Glass fiber $k=0,04$ [W/m C]
 - Air (still) $k=0,024$ [W/m C]



➤ Heat Transfer through a joint Contact (interface):

➤ $Q = G_c A_c (T_1 - T_2) \rightarrow \text{LINEAR}$

- **A_c**= contact area [m^2]
- **G_c**=Contact Conductivity [$\text{W/m}^2 \text{ C}$] (bare contact, thermal interfiller)



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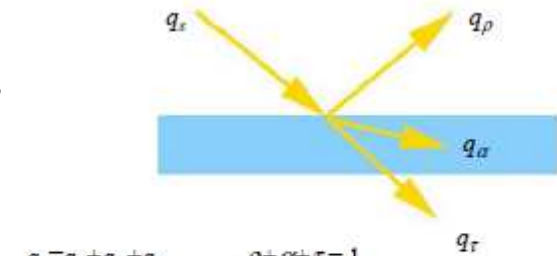
2. SPACE THERMAL ENVIRONMENT AND HEAT TRANSFER

Heat Transfer by **Radiation** (main mode in vacuum /space)

- propagation of electro-magnetic energy in straight line, between surfaces
- reflected, absorbed or transmitted on surrounding bodies

proportional to T^4 (Stefan-Boltzmann law: $q = \epsilon \sigma T^4$)

- σ = Stefan-Boltzmann (5.6705×10^{-8}) [W/m^2K^4]
- ϵ = I/R emissivity (dimensionless number between 0 and 1 which relates emission to that of a black body)



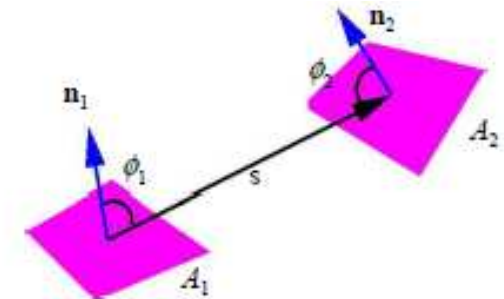
$$q_s = q_p + q_a + q_r$$

$$\rho + \alpha + \tau = 1$$

ρ =reflectivity
 α =absorptivity
 τ =transmissivity

when view factors (Vf) apply to radiation exchange between surfaces, the radiative heat transfer equation is:

- $Q = (A \times Vf) \times \epsilon_{eq} \times \sigma \times (T_1^4 - T_2^4)$ [W] (T =temp (K))
- Vf= View Factor between two facing surfaces
- ϵ_{eq} = Equivalent Infrared Emissivity



Absorbed Solar Flux: $Q = S \times A \cos(\beta) \times \alpha$

- S =solar constant (1330 / 1420 W/m^2 , at 1 AU)
- α = Solar Absorptivity; β = Sun Aspect Angle

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2. SPACE THERMAL ENVIRONMENT AND HEAT TRANSFER

➤ Energy Balance: $dQ_{int} + dQ_{ext} = dQ_{rej}$ [W]

➤ dQ_{int} = thermal power generated inside the s/c (electronics, chemical reactions, thermal control, ...)

➤ dQ_{rej} = heat flux rejected to external environment (toward a Sink Temp), is the sum of all radiative contribution from the S/C external surfaces to a Sink Temperature (Space), the most important contribution comes from radiators

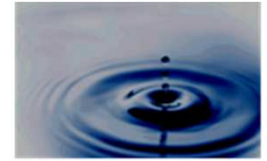
➤ dQ_{ext} = heat flux absorbed, generated by external sources (dQ (Sun) + dQ (Albedo) + dQ (Planet I/R) + dQ (radiative exchange with other external surfaces as in the case of complex space systems)

➤ In non equilibrium conditions:

$$dQ_{int} + dQ_{ext} = dQ_{rej} + M c_p dT/dt$$

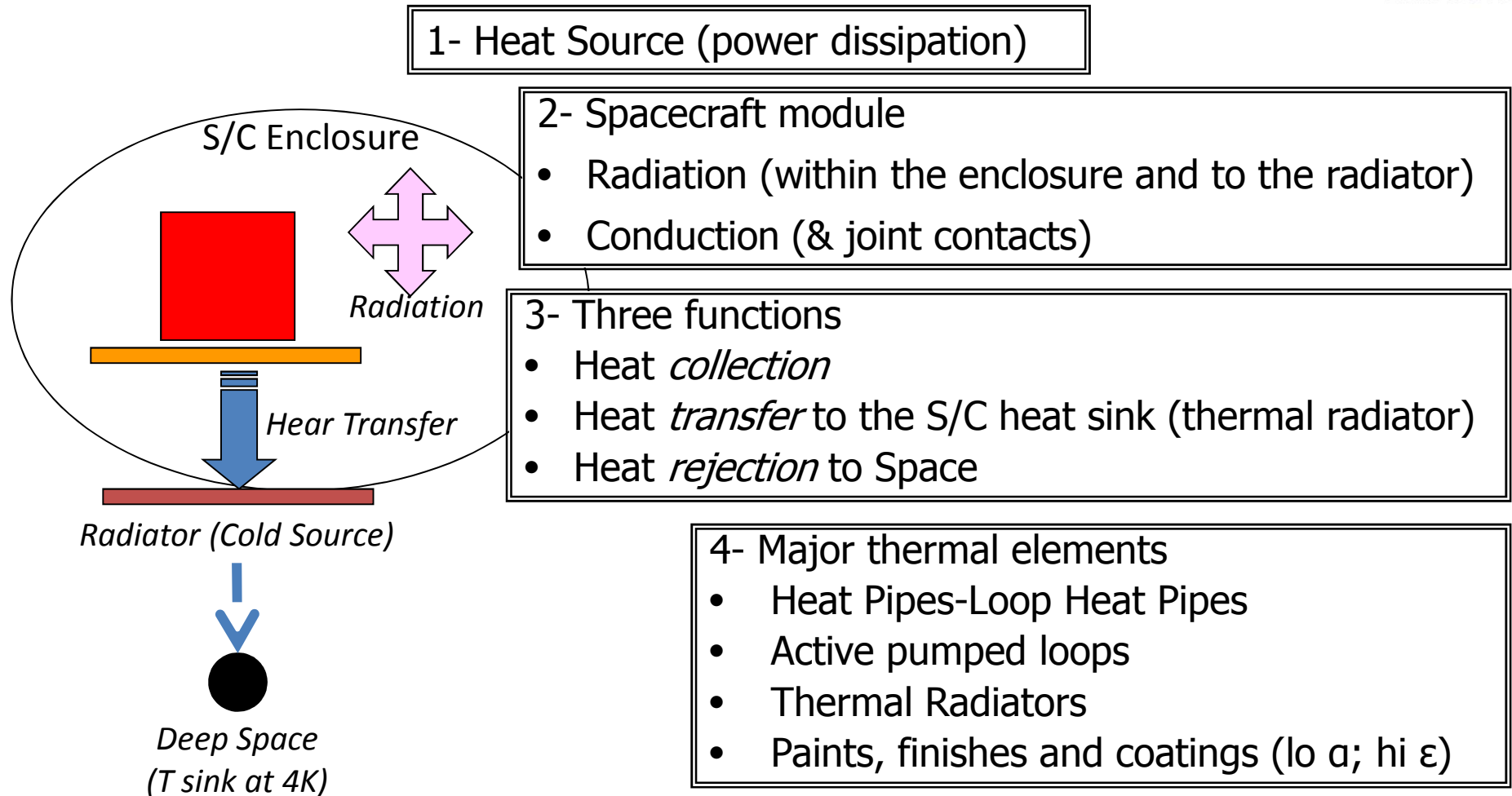
➤ where c_p is the thermal capacity of the system.

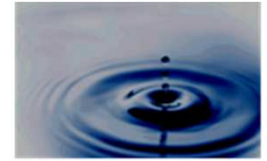
➤ Equilibrium temperatures are those values resulting from the solution of the energy balance equation system.



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3. THERMAL ARCHITECTURE SCHEME (HEAT TRANSFER TO A SINK)

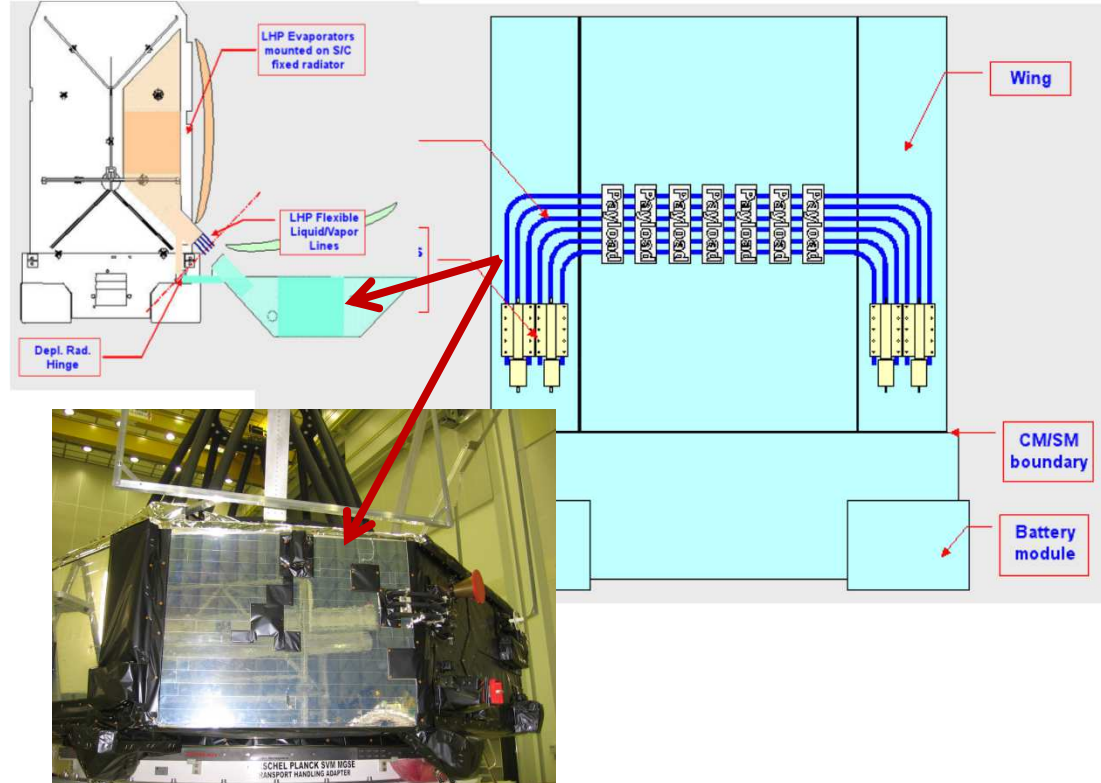


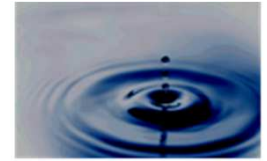


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3. THERMAL ARCHITECTURE SCHEME (HEAT TRANSFER TO A SINK)

- The heat generated in a Spacecraft by electronic devices, chemical reactions, payloads, thermal control devices must be collected and forwarded to specific heat sinks (internal S/C, fluidic interfaces and eventually thermal radiators).
- The heat flux is naturally transferred in a ***“passive”*** way by conduction and/or radiation; exchanged heat flows from hotter to colder elements down to the heat sink.
- Use of fluidic devices can facilitate the control of the heat transfer toward specific radiator elements (HP, LHP, ATCS)



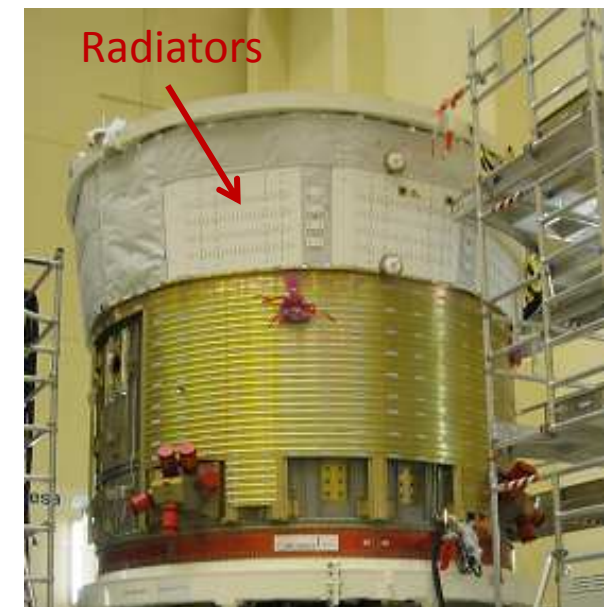


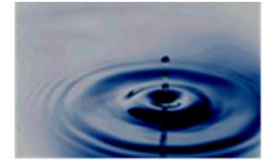
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3. HEAT TRANSFER TO A S/C COLD SINK

- **Heat Pipes** and **Loop Heat Pipes** are fluidic components working at nearly isothermal conditions (two-phase capillary loops), linking dissipating sources to the radiator
- **Radiators** are equipped with high emissivity external finishes (tapes, mirrors, paints)
- Heat Rejection capability of Thermal radiators at different Temperature levels are ($V_f=0,94$; $\epsilon=0.8$; $A=1 \text{ m}^2$)

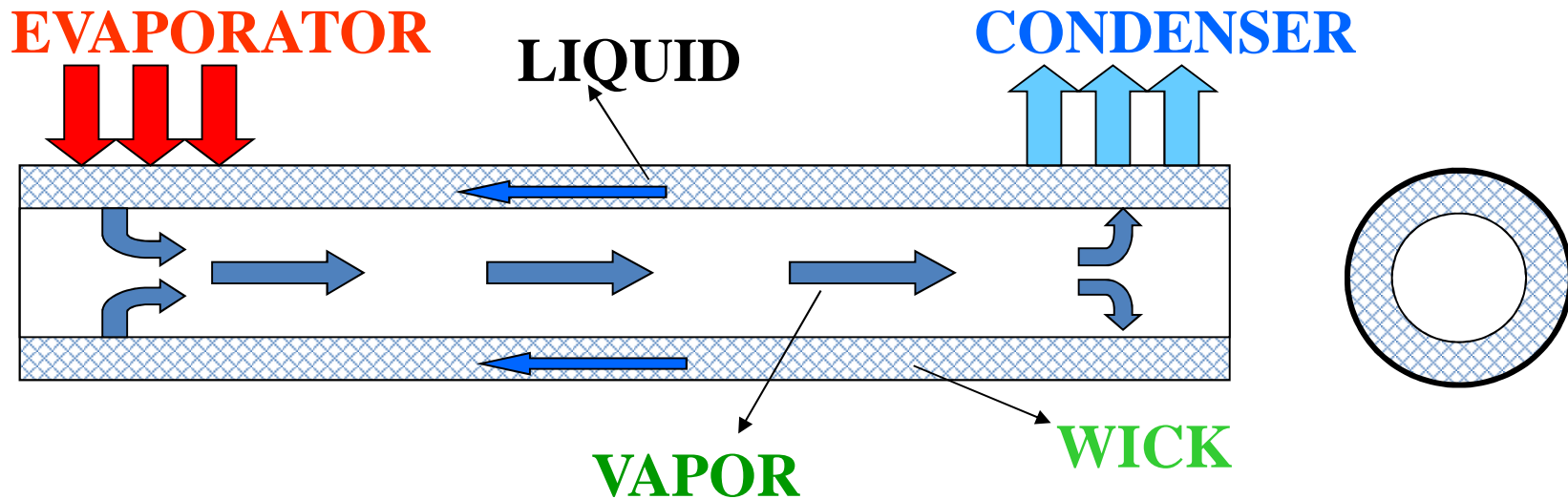
Q Rejected to space	T= 20°C	T= 30°C	T= 40°C	T= 50°C
η (efficiency)	$314 \cdot \eta - Q_{\text{ext}}$ [W/m ²]	$359 \cdot \eta - Q_{\text{ext}}$ [W/m ²]	$410 \cdot \eta - Q_{\text{ext}}$ [W/m ²]	$464 \cdot \eta - Q_{\text{ext}}$ [W/m ²]
Typical η	From 0,85 to 0,96			



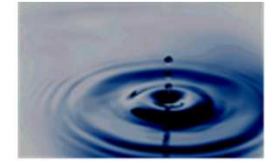


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3. HEAT TRANSFER TO A S/C COLD SINK

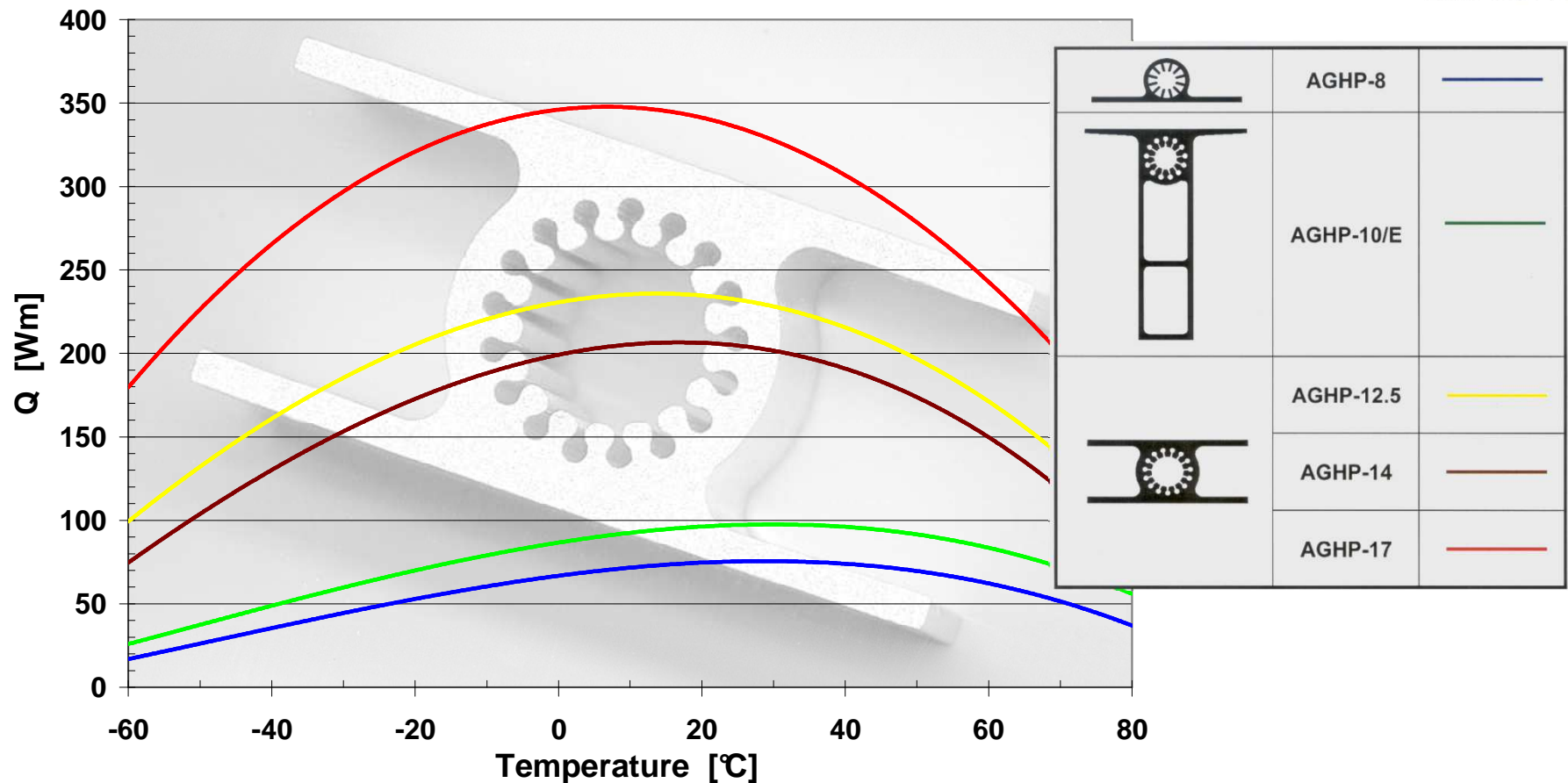


- **Heat Pipes** transfer heat from a source to a sink with minimum temp. gradient
- Passive heat transfer device with high effective thermal conductivity
- Isothermal boiling-condensing cycle
- No moving parts: high reliability and long life
- proper choice of coolant vs pipe material according to the operating temperature range

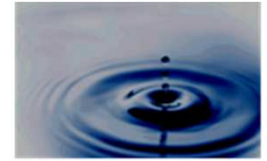


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3. HEAT TRANSFER TO A S/C COLD SINK



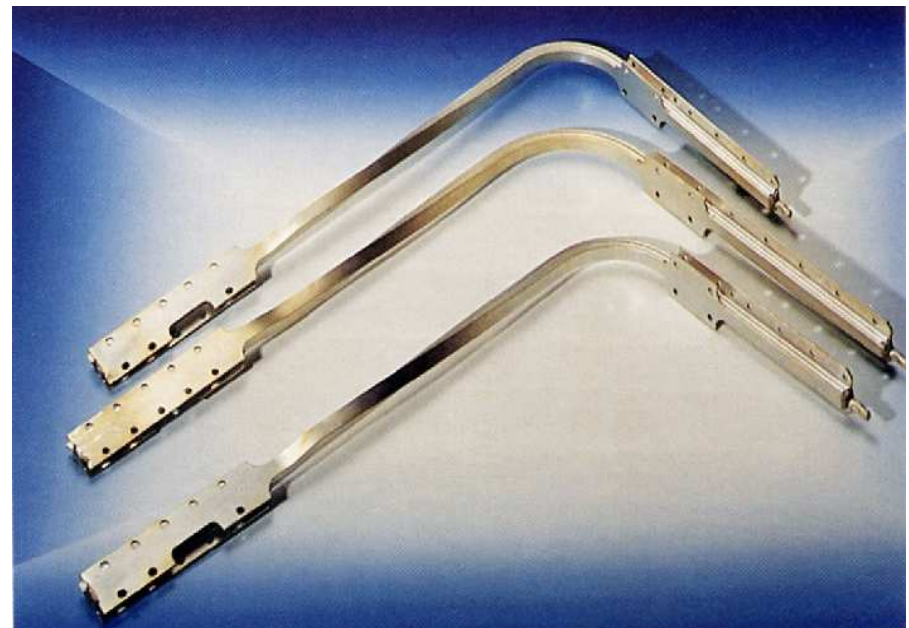
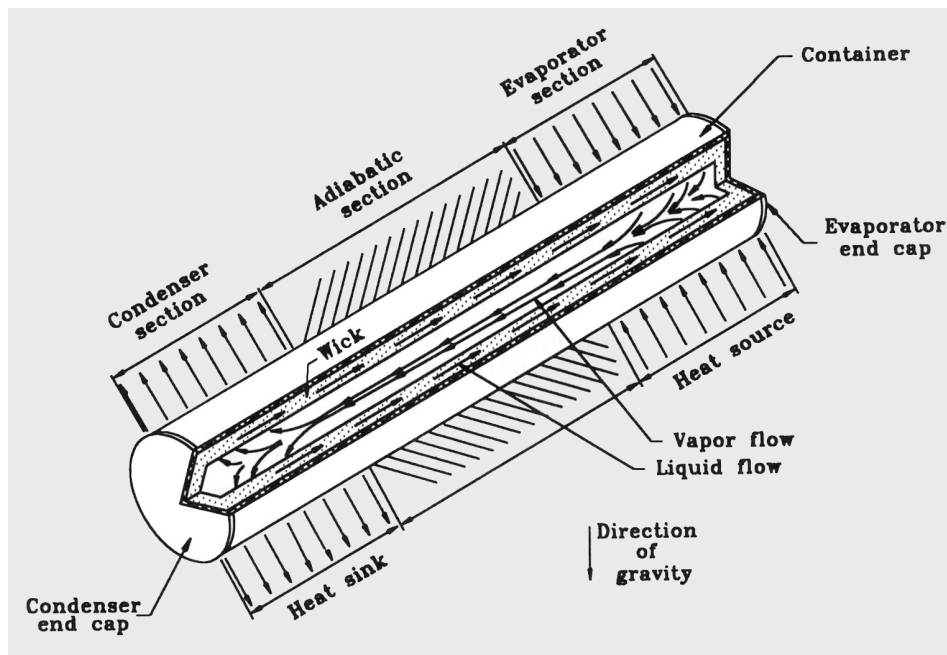
Axially Grooved Heat Pipe Performance (example)



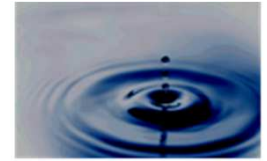
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3. HEAT TRANSFER TO A S/C COLD SINK

- The most obvious application of a heat pipe is the one where heat source and sink are physically separated.



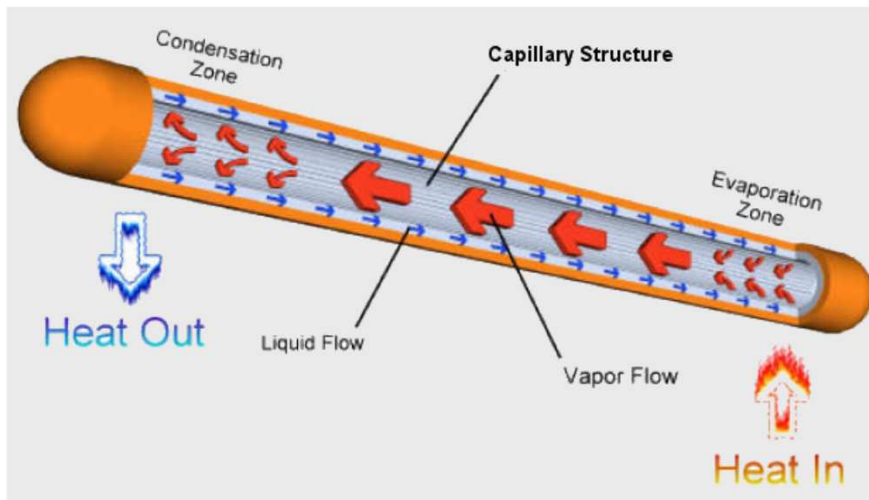
- This configuration is also the one conventionally adopted when the heat pipes are tested (for qualification and acceptance)

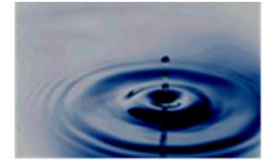


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3. HEAT TRANSFER TO A S/C COLD SINK

- **Heat Pipes** and **Two-phase Capillary Loops** are closed two-phase fluid circuits with an evaporator and a condenser to transport relatively large quantities of heat from a source to a sink without electrical power thanks to the capillary head.

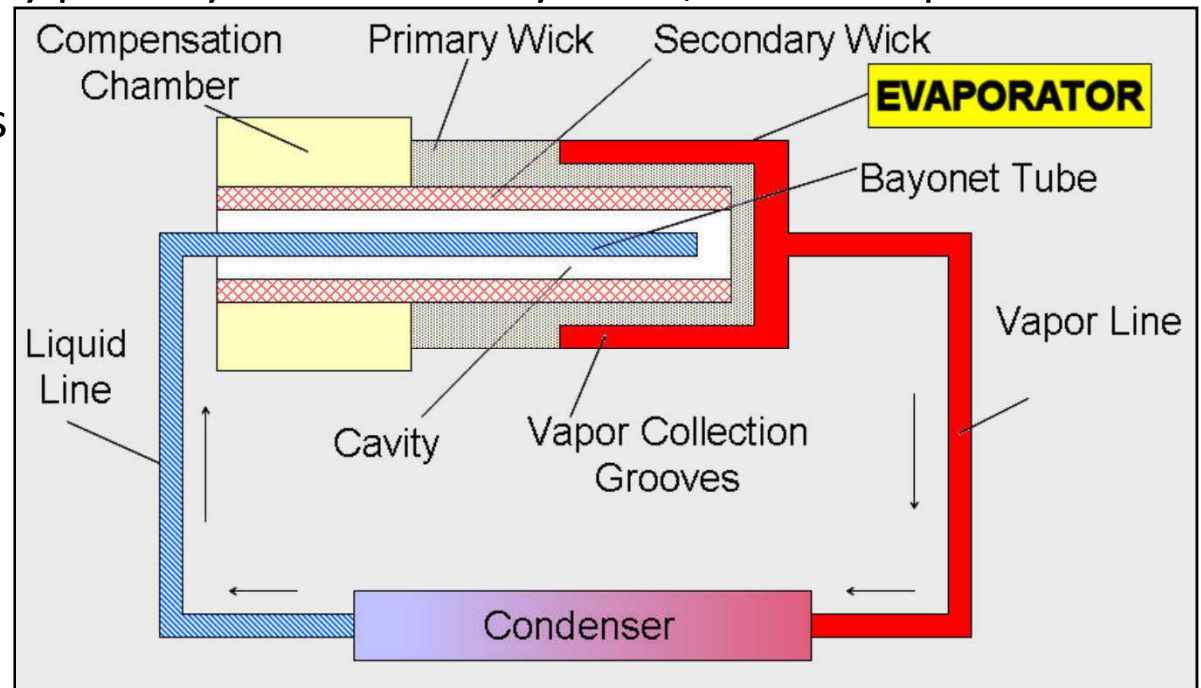


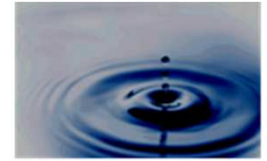


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3. HEAT TRANSFER TO A S/C COLD SINK

- A 2-phase Capillary Loop is composed by: **Evaporator** (heat collection), **Condenser** (rejection), **Liquid Phase/Vapor Phase Lines** (transport) and **Reservoir** (Compensation chamber) → supports heat transport from few [W] to several [kW]
- **Capillary head** provided by primary and secondary wicks, in the evaporator
- Multi-evaporator and multi-condenser systems are under development
- **Robust concept**: Low sensitive to bubbles in the evaporator
- **Control**: by heater on the Compensation Chamber (small fraction of LHP power)

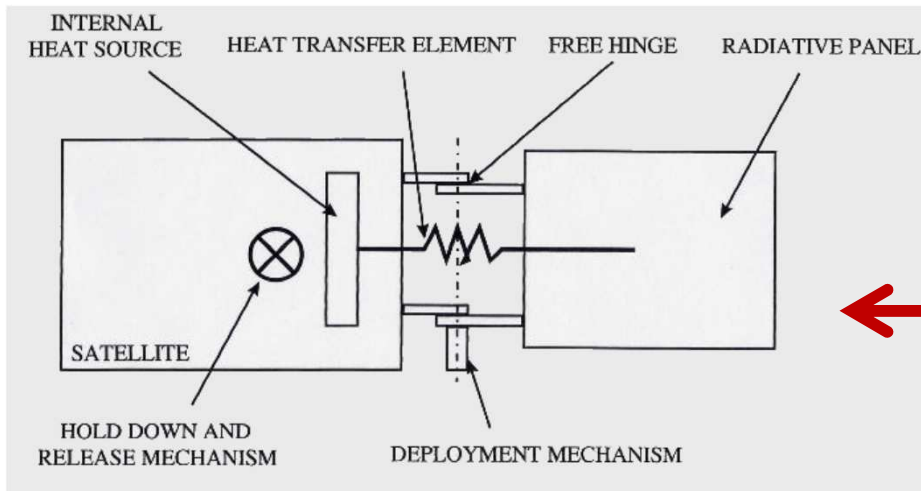
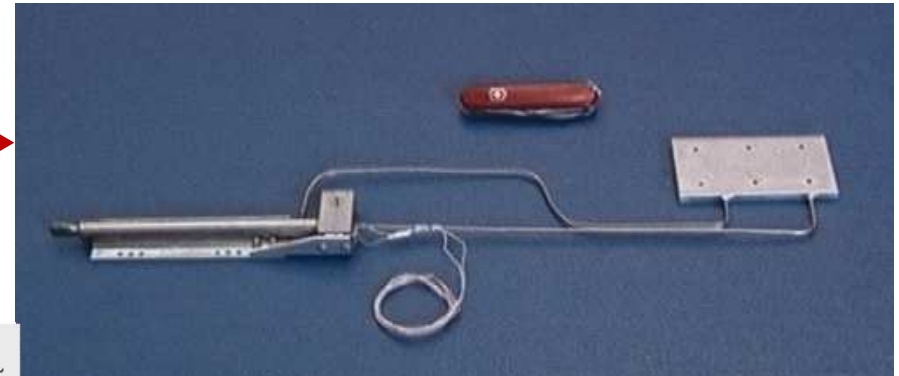




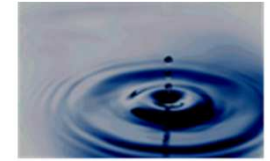
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3. HEAT TRANSFER TO A S/C COLD SINK

- Individual thermal control of a single equipment box with heat sink located elsewhere



- Thermal connection between spacecraft main body and fixed or Deployable Radiators

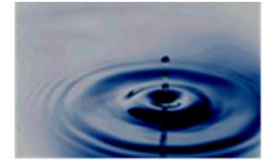


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3. HEAT TRANSFER TO A S/C COLD SINK

Two-phase Capillary Loop main advantages:

- Tolerance of large adverse tilts (heat source up to 5 m above heat sink) facilitating ground tests and terrestrial applications
- Tolerance of complicated layouts and transport paths
- Easy accommodation of flexible sections (e.g. in deployable radiators)
- Fast and strong “diode” action
- Straightforward application in either constant conductance or variable conductance (active temperature control) mode

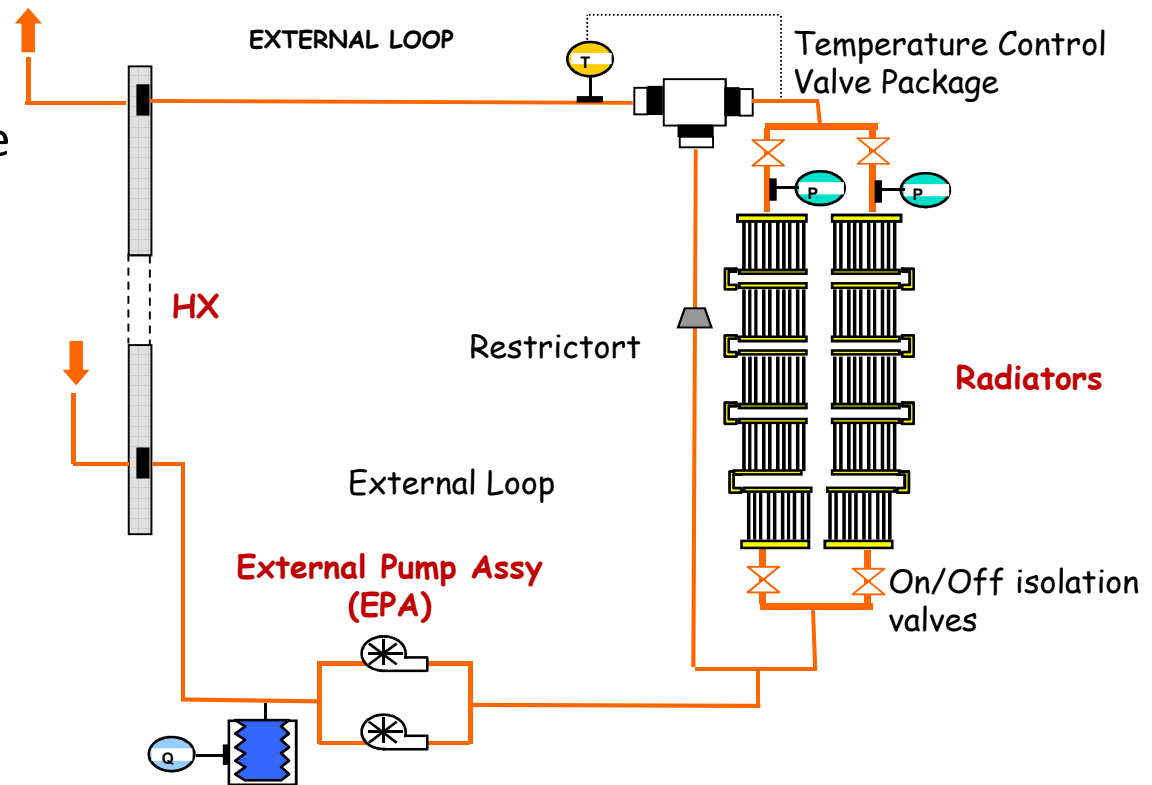


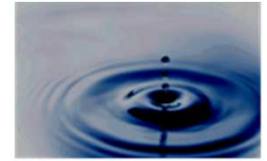
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3. HEAT TRANSFER TO A S/C COLD SINK: ATCS architecture

Main Critical elements:

- Choice of coolant
- Single phase / Two phase
- Redundancy
- Cold plates & HX
- Temperature drop
- Pressure drop
- Flow rate
- Radiators concept & architecture (serial, parallel configuration)
- Radiator performance
- Pump working point



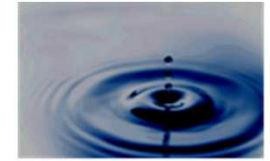


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4. SPACECRAFT COLD SOURCE (SINK)

Thermal Radiators

- Radiator provides the cold source to the spacecraft (S/C) thermal control. It is a heat exchanger that transfers the waste heat from the S/C to the radiation temp. environment of space. Waste heat is then ultimately rejected to space by radiator surfaces.
- Optimised radiator area requires:
 - Efficient thermal optical properties (surface coating)
 - Efficient thermal distribution over the whole surface (high thermal conductivity materials and efficient thermal transfer solutions (HP, fluid loop)
 - Radiator average temperature as high as possible (efficiency increases as the radiator temperature increases, according to $q = \varepsilon \sigma T^4$)

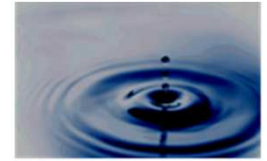


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4. SPACECRAFT COLD SOURCE (SINK)

Thermal Radiators

- Radiators can use, proper hi thermal conductivity structural materials, heat pipes, fluid loop or a combination of the above solutions
- Radiator configuration:
 - structural panel
 - Body mounted (i.e. fixed to a structure)
 - Deployable
- Designed to environmental conditions (Micro Meteoroid & Debris, Atomic Oxygen, Radiation, other ...)

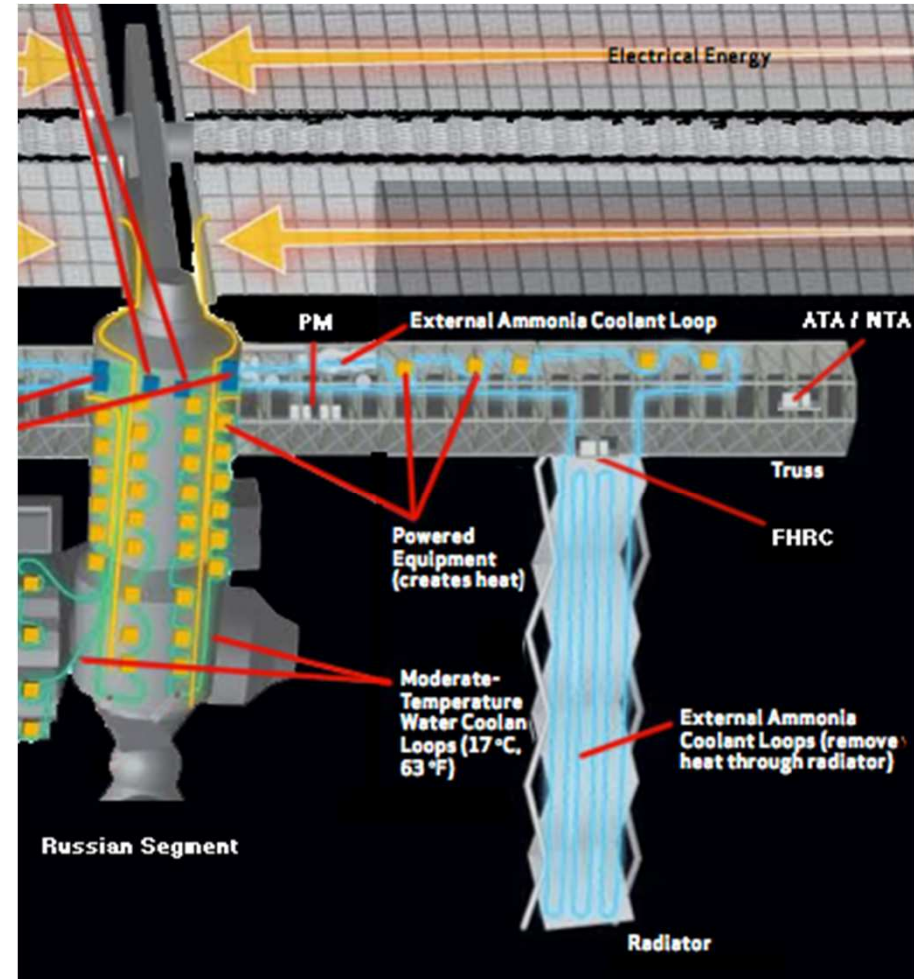


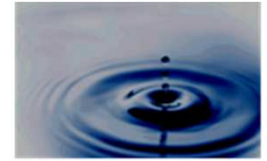
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4. SPACECRAFT COLD SOURCE (SINK)

Radiator technology

- Pumped circuit radiator
circulation of a liquid in a fluid circuit
- through pump(s)
- (e.g. ISS radiators, temperature 300K and area, 450m², consolidated technology)





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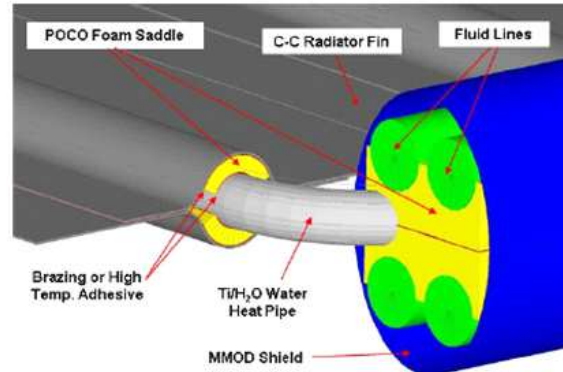
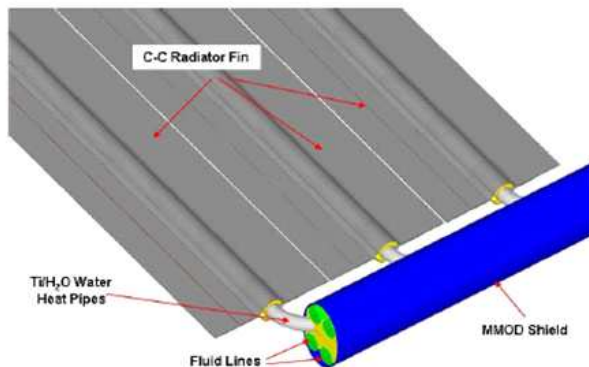
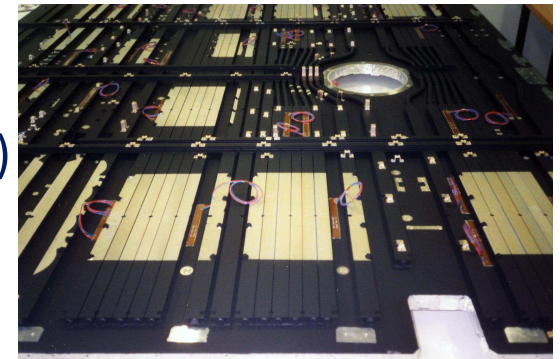
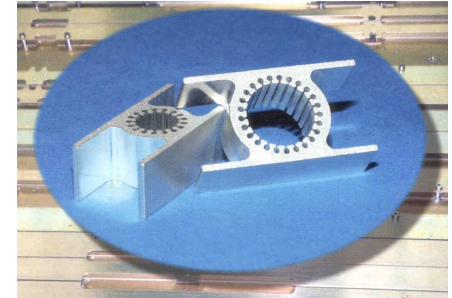
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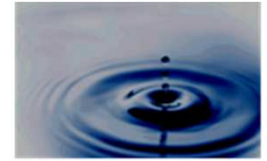
4. SPACECRAFT COLD SOURCE (SINK)

Heat pipes radiators

Radiator equipped with a network of heat pipes to spread the heat at an isothermal temperature level.

- meteoroid impact could damage a single item, no impact on the radiator system functionality
- capillary action to return the liquid from condenser to evaporator, no pumps
- radiator of reduced mass (using honeycomb sandwich)
- widely used in space applications





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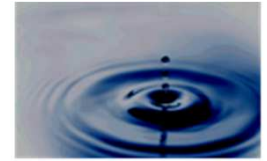
4. SPACECRAFT COLD SOURCE (SINK)

Heat pipes radiators

Issues:

- Selection of materials and design → working fluid compatibility with piping and radiator manufacturing technologies, heat exchanger concept, operating temperature range

	Melting point, K a 1 atm	Boiling Point, K at 1 atm	Useful range, K	Compatible material	Incompatible Material
Ammonia	195,5	239,9	233-360	Aluminum, stainless steel, Nickel	Copper
Freon	236	320	263-373	Aluminum	
methanol	175,1	337,8	283-403	Stainless steel, iron , nickel	Aluminum
Water	273,1	373,1	303-473	Stainless steel, copper, nickel, titanium	Aluminum, Inconel
sodium	371	1151	873-1473	Stainless steel, nickel, Inconel, niobium	titanium



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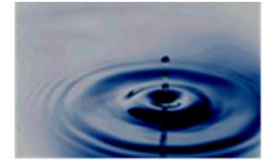
4. SPACECRAFT COLD SOURCE (SINK)

Loop Heat Pipes Radiator

As for the heat pipes issues are still open for high temperature above 500/550K,
for the right selection of the working fluid

Development of Multievaporator /multicondenser concept





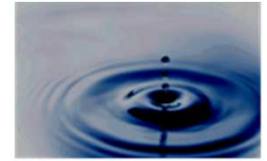
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4. SPACECRAFT COLD SOURCE (SINK)

Droplet Radiator

Liquid is expelled in form of fine droplets from a generator and then recuperated in a collector

- circulation of a liquid is assured by additional pump(s)
- no need of radiant metallic surface: the droplets provides themselves a high radiant surface
- performance would be very attractive for radiator: 4kg/m
- working fluid could be silicon-based oil or a liquid metal, because their low vapor pressure, minimizing the losses during the droplets transmission from generator to collector
- part of working fluid is sublimated to space: needs of a reservoir
- Mass impact for new components
- Radiator technology free of meteoroids impact and deployment / on-orbit assembly issues

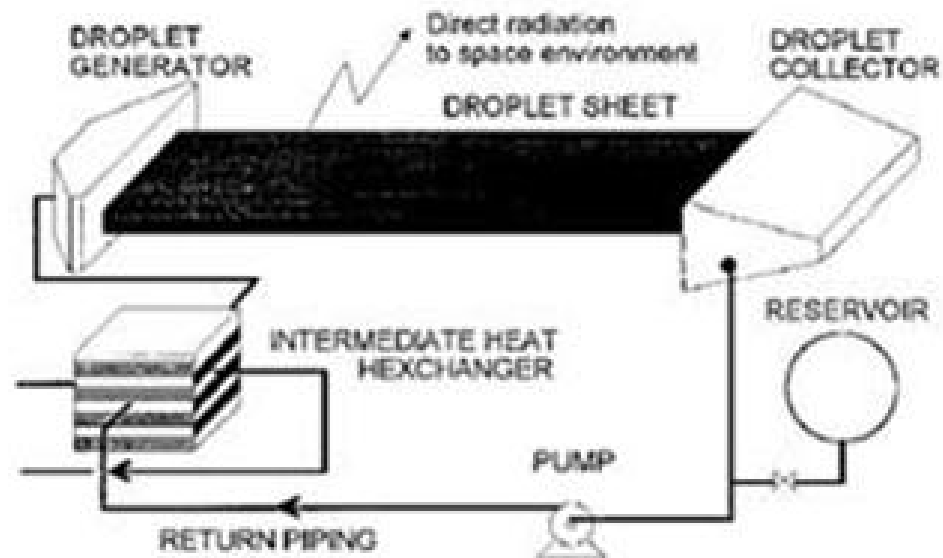


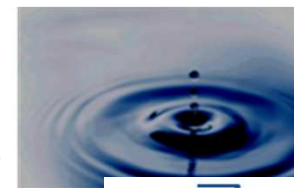
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4. SPACECRAFT COLD SOURCE (SINK)

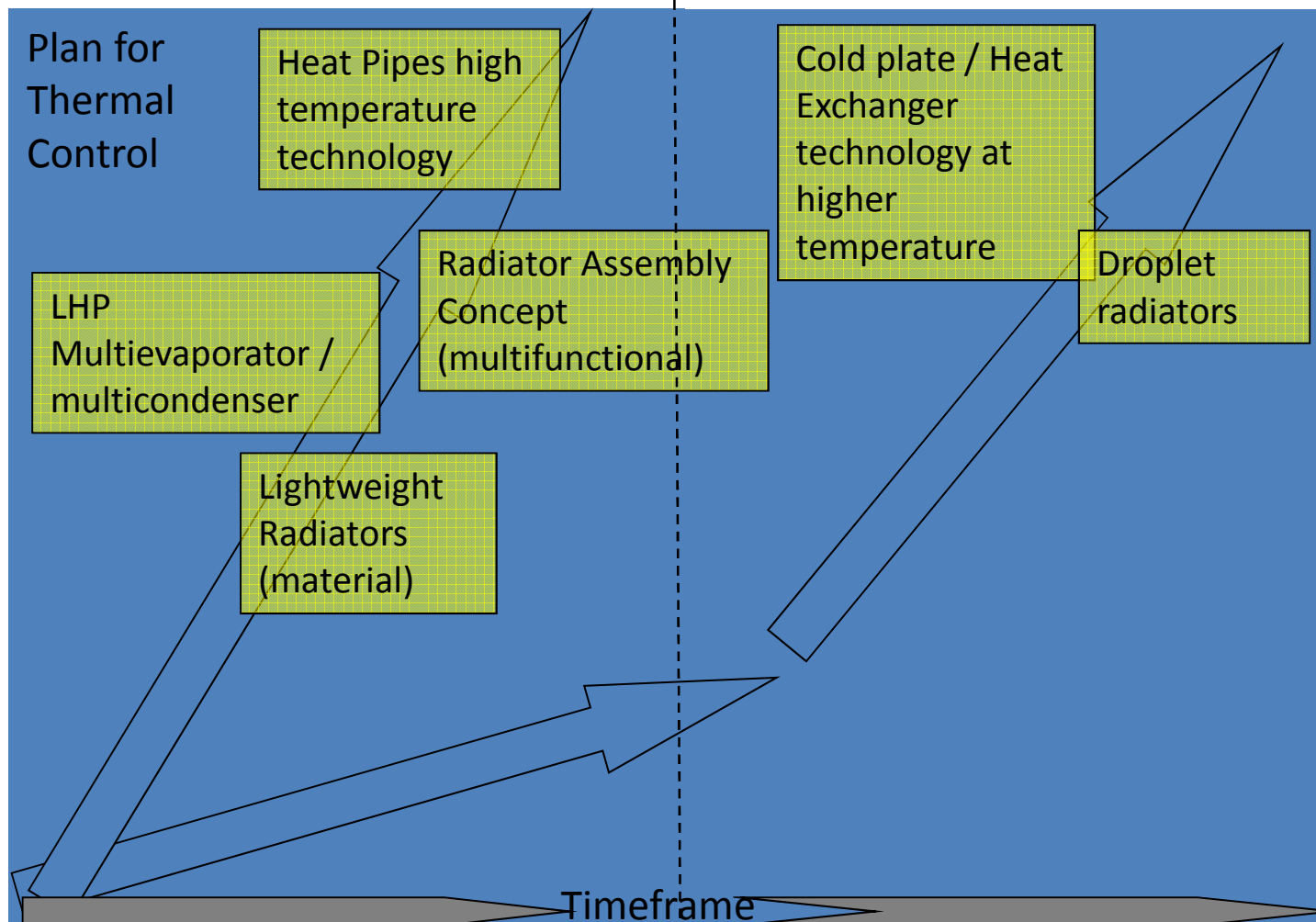
Droplet Radiator (cont.'d)

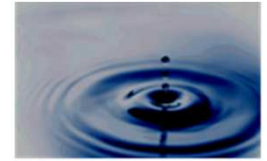
- Up to 300 K, the silicon oils are suggested or eutectic compound as NaK
- From 600 to 1000 K liquid metals (Lithium, Sodium, Indium and Tin) are available, practically opaque, they have a low emissivity value ($\epsilon = 0.1$). As example, to increase their performance for emissivity, a fine black carbon powder has to be added
- Technology experiments currently planned to demonstrate the Droplet Radiator technology.





5. COLD SOURCE IN SPACE: FUTURE DEVELOPMENT





SPACE TRIPS SUMMER SCHOOL - COLD SOURCE IN SPACE

5. CONCLUSIONS

- a) Cold sources in space are basically constrained by the natural cold sink (deep space) and by the mean of heat exchange with it (i.e. by radiation)
- b) The key elements are:
 - the thermal radiator
 - the means for heat collection and transport
- c) Basic technologies for heat collection and transport include (beside pure passive means:
 - heat Pipes and LHP
 - Fluid loops (single and two phase)
- d) Technologies for conventional operating temperature range (250/+370K) are consolidated
- e) New development focused on improving radiator performances in terms of weight (lightweight), thermal efficiency, reliability, hi-temperature range (450-600K) for HP and LHP.